



ZVN4310G

100V N-CHANNEL ENHANCEMENT MODE VERTICAL MOSFET IN SOT223

Features and Benefits

- V_{(BR)DSS} > 100V
- $R_{DS(ON)} \le 0.54\Omega$ @ $V_{GS} = 10V$
- Maximum Continuous Drain Current I_D = 1.67A
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

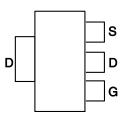
- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish (e3)
- Weight: 0.112 grams (Approximate)

Applications

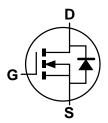
- DC-DC Converters
- · Solenoids / Relay Driver for Automotive



Top View



Pin Out - Top



Equivalent Circuit

Ordering Information (Note 4)

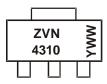
Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZVN4310GTA	ZVN4310	7	8	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

SOT223



ZVN4310 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01~53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	100	V
Gate-Source Voltage	V_{GSS}	±20	V
Continuous Drain Current	Ι _D	1.67	A
Pulsed Drain Current (Note 6)	I _{DM}	12	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 5)	P _D	3	W
Thermal Resistance, Junction to Ambient	(Note 5)	R _{0JA}	41.7	°C/W
Thermal Resistance, Junction to Leads	(Note 7)	R _{0JL}	8.84	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	-	-	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	-	-	10 100	μA μA	$V_{DS} = 100V, V_{GS} = 0V$ $V_{DS} = 80V, V_{GS} = 0V, T_A = +125$ °C	
Gate-Source Leakage	I _{GSS}	-	-	±20	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
On-State Drain Current	I _{D(ON)}	9	-	-	Α	V _{GS} = 10V, V _{DS} = 10V	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1	-	3	V	$V_{DS} = V_{GS}$, $I_D = 1mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	0.4 0.5	0.54 0.75	Ω	$V_{GS} = 10V, I_D = 3.3A$ $V_{GS} = 5V, I_D = 1.5A$	
Forward Transconductance		0.6	-	-	S	$V_{DS} = 10V, I_D = 3.3A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	-	-	350	pF	$V_{DS} = 25V, V_{GS} = 0V,$	
Output Capacitance	Coss	-	-	140	pF		
Reverse Transfer Capacitance	C _{rss}	-	-	20	рF	- f = 1.0MHz	
Turn-On Delay Time	t _{D(ON)}	-	-	8	ns		
Turn-On Rise Time	t _R	-	-	25	ns	$V_{DD} = 25V, I_D = 3A, V_{GEN} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	-	-	30	ns	$R_{GS} = 50\Omega$	
Turn-Off Fall Time	t _F	-	-	16	ns		

Notes:

- 5. For a device mounted on 50mm X 50mm X 1.6mm FR-4 PCB with high coverage of single sided 2oz copper, in still air condition.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.
- 7. Thermal resistance from junction to solder-point (at the end of the drain lead).
 8. Short duration pulse test used to minimize self-heating effect.



Electrical Characteristics

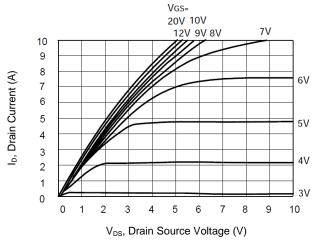


Figure 1. Saturation Characteristics

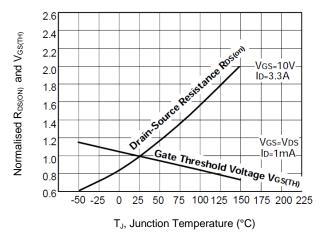


Figure 3. Normalised $R_{\text{DS}(\text{ON})}$ and $V_{\text{GS}(\text{TH})}$ vs. Temperature

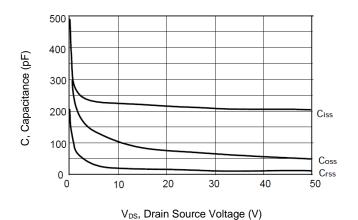


Figure 5. Capacitance vs. Drain-source Voltage

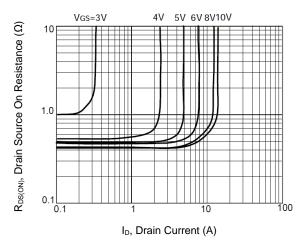


Figure 2. On-resistance vs. Drain Current

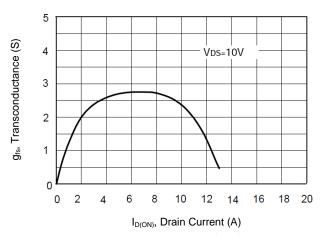


Figure 4. Transconductance vs. Drain Current

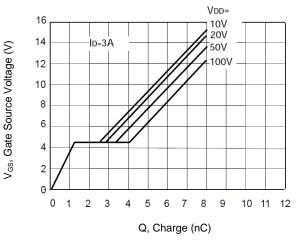
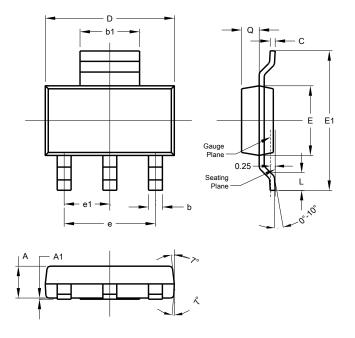


Figure 6. Gate Charge vs. Gate-source Voltage



Package Outline Dimensions

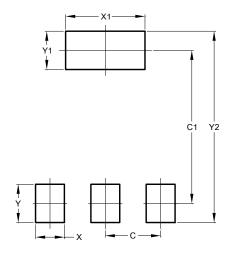
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00



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